



COMPANY PROFILE

Tianjin Elco Automation Co., Ltd. is a leading enterprise in industrial automation in China. It was established in 2003 with a sales and service network covering the whole country. As a provider of domestic industrial automation products and intelligent manufacturing solutions, Elco holds a leading position in various fields such as automobiles, automotive parts, engineering machinery, new energy, logistics equipment, food & pharmaceuticals, printing & packaging, textile machinery, electronic manufacturing, etc.

From the system layer, control layer, network layer to execution layer, Elco provides a full range of services for intelligent manufacturing top to bottom. Ous products and solutions include but are not limited to cloud platforms, MES manufacturing execution systems, industrial fieldbus, industrial Ethernet, industrial wireless communication, IoT gateways, automated production lines composed of robots and intelligent devices, integration of automated electrical control systems, intelligent logistics warehousing systems, IoT integrated solutions and services, industrial technology software based mobile solutions, Elco Cloud · Industrial Internet Platform, etc., comprehensively help enterprises achieve intelligent manufacturing.

From 2016, Elco won the bid for the National Ministry of Industry and Information Technology's major intelligent manufacturing project for two consecutive years. In 2018, Elco was honorably selected and became a nationally recommended and supported intelligent manufacturing system solution supplier. From 2019, Elco won the bid for the Ministry of Industry and Information Technology's high quality development project for two consecutive years. In 2020, Elco's application for the "Industrial Internet Platform for the Automobile Manufacturing Industry" was rated as a national level specialized industrial Internet Platform. In 2021, Elco was honorably selected as the professional, refined, characteristic and Innovative key "Little Giant" enterprise by the Ministry of Industry and Information Technology of China. In 2022, Elco was selected as the National Enterprise Technology Center.

Elco defines "automation+digital factory+industrial internet" as an important development strategy. In 2017, under the guidance of the Tianjin Municipal Science and Technology Commission, Elco initiated the establishment of the Tianjin Automation and Information Technology Innovation Strategic Alliance, and relied on the alliance's investment to establish the Elco • XEDA Industrial Internet Application Innovation Promotion Center.

Nowadays, with the coming of the industrial internet era, traditional industrial models have been impacted unprecedentedly, and the integration of the internet and manufacturing industry has gradually been elevated to a strategic level. Elco will promote the development of industrial Internet with unremitting innovation pursuit, accelerate the process of intelligent manufacturing, and build a new ecosystem of industrial Internet+intelligent manufacturing.



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The 3D laser profile sensor uses a super-high-speed processor to accurately scan and process the outline and size of the object, providing real-time contour and point cloud data and output the results.

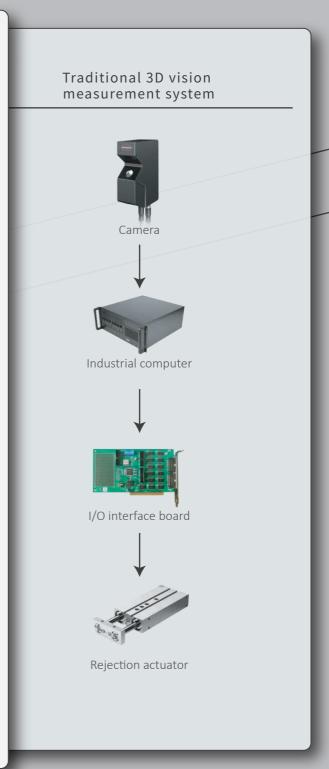
The product adopts an integrated structure, built-in embedded 3D measuring tools, does not require any external computing equipment such as industrial computer, can independently complete real-time size measurement and defect detection tasks, and has a wide range of applications in lithium, new energy, consumer electronics, automotive, food, pharmaceutical, logistics and other industries.



It integrates scanning, measurement and control

The measurement results can be directly output to the actuator, eliminating the industrial computer and I/O interface board in the traditional 3D vision measurement system, greatly reducing the complexity of the system, and saving costs for customers.

Smart 3D sensor sensor Highly integrated Simplified operation Flexible mounting Rejection actuator



Product Specification

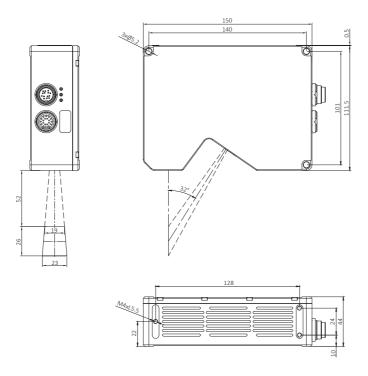
LVM21 SERIES

Model		LVM2120	LVM2130	LVM2140	LVM2150	LVM2160	LVM2170	
Data points		1456	1456	1456	1456	1456	1456	
Clearance distance (mm)		52	65	162	291	360	350	
Measurement ran	nge (mm)	26	89	195	368	485	842	
	Proximal	19	43	90	144	260	456	
Field of view (mm)	Reference distance	21	57.5	123	208	405	808	
	Remote	23	72	156	272	550	1160	
Resolution (μm)	X (Width) (μm)	13.1-15.8	29.6-49.5	61.9-107.2	98.9-186.9	178.6-377.8	313.2-796.7	
Repeatability Z (μ	m)	0.5	1	1.2	1.8	6	10	
Linearity Z (+/- %	of MR)	0.01%	0.01%	0.01%	0.01%	0.05%	0.05%	
Light source wave	length	405nm 660nm						
Laser class		2,3R						
Dimensions (mm)		44x111.5x150	44x99x148	44x99x213	44x99x278	44x99x284	44x99x284	
Weight (kg)		0.89	0.87	1.05	1.45	1.44	1.44	
Enclosure materia	al	Aluminium						
Temperature char	acteristics	0.01%						
Scan rate		270-5000Hz						
Inputs		Differential rncoder, laser safety enable, trigger						
Outputs		2 x digital output, RS-485 serial, 1 x analog output						
Protocols		Modbus TCP、PROFINET、ASCII						
Protection class		IP67 inserted and tightened						
Ambient light		Incandescent Lamp:≤10000lux						
Operating temper	ature	0 °C +50 °C						
Storage temperat	ure	-30 °C +70 °C						
Working humidity	1	20%-85% RH						
Vibration resistance 10 to 55 Hz, 1.5 mm double amplitude in X, Y and Z directions, 2 hours per direction			on					
Shock resistance			15 g/11 ms, positive and negative for X, Y and Z directions					
Electromagnetic protection EN 6132				61326-1:2013 (GB/T18268), EN 55011:2007-11 (GB4824, group 1, A class), EN 61000-6-2:2006-03(GB/T17799.2)				

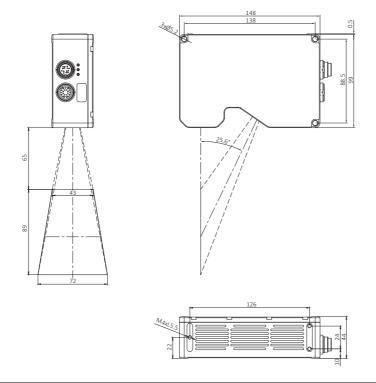


Outline dimensional drawing

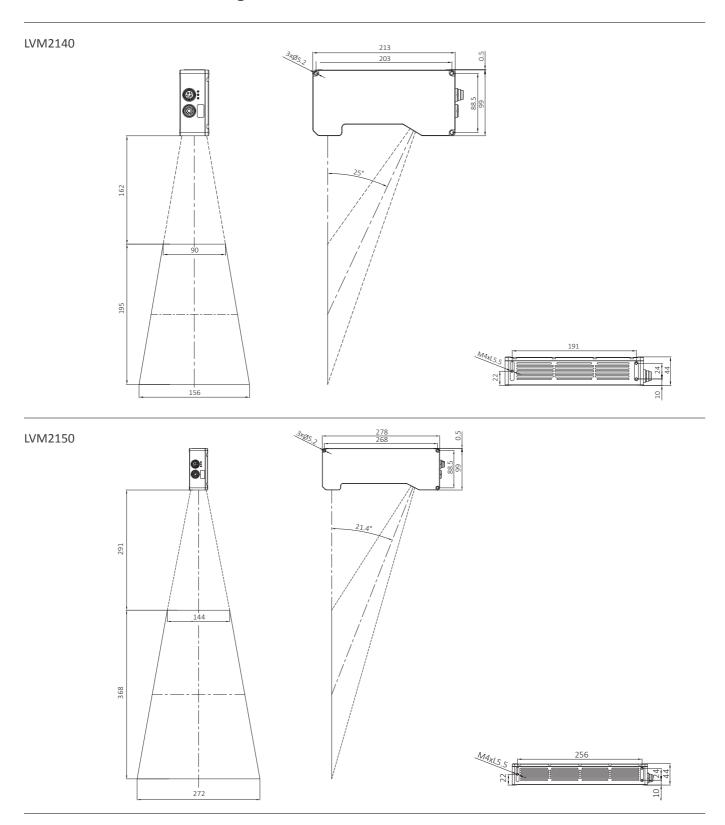
LVM2120



LVM2130

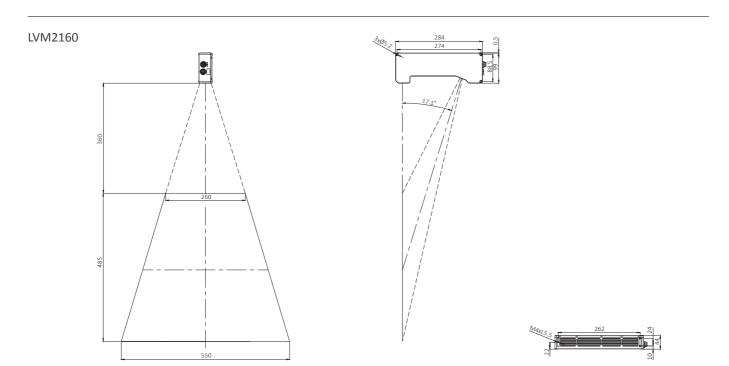


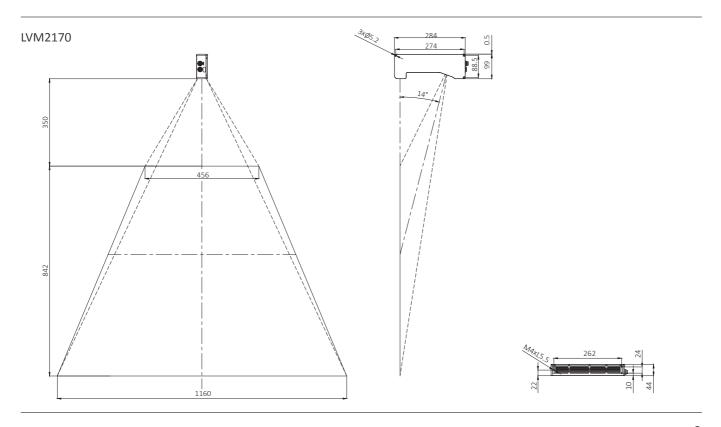
Outline dimensional drawing





Outline dimensional drawing





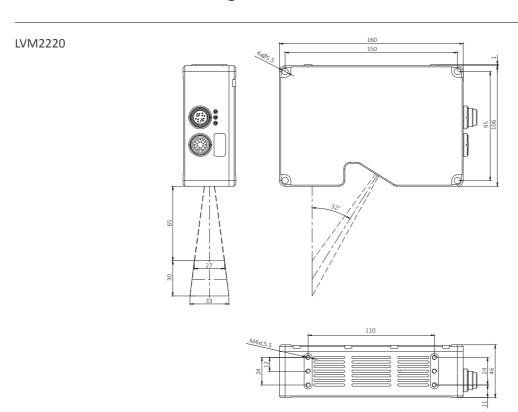
| | Product Specification

LVM22 SERIES

Model		LVM2220	LVM2230	LVM2240	LVM2250			
Data points		2048	2048 2048		2048			
Clearance distance (mm)		65	67 156		274			
Measurement rar	nge (mm)	30	68 186		356			
Field of view (mm)	Proximal	27	48	92	147			
	Reference distance	30	60	128.5	219			
	Remote	33	72	165	291			
Resolution (μm)	X (Width) (μm)	13.0-16.5	23.4-34.8	44.8-80.8	72.0-142.3			
Repeatability Z (μ	m)	0.4	0.8	1	1.5			
Linearity Z (+/- % of MR)		0.01%	0.01%	0.01%	0.01%			
Light source wavelength		405nm						
Laser class		2,3R						
Dimensions (mm)		46x106x160	46x105.5x170	46x106x195	46x106x250			
Weight (kg)		0.9	0.92	1.06	1.48			
Enclosure materia	al	Aluminium						
Temperature characteristics		0.01%						
Scan rate		240-5000Hz						
Inputs		Differential encoder, laser safety enable, trigger						
Outputs		2 x digital output, RS-485 Serial, 1 x analog output						
Protocols		Modbus TCP, PROFINET, ASCII						
Protection class		IP67 inserted and tightened						
Ambient light		Incandescent Lamp:≤10000lux						
Operating temper	rature	0 °C +50 °C						
Storage temperature		-30 °C +70 °C						
Working humidity		20%-85% RH						
Vibration resistance		10 to 55 Hz, 1.5 mm double amplitude in X, Y and Z directions, 2 hours per direction						
Shock resistance		15 g/11 ms, positive and negative for X, Y and Z directions						
Electromagnetic រុ	protection	EN 61326-1		013 (GB/T18268), EN 55011:2007-11 (GB4824, group 1, A class), EN 61000-6-2:2006-03 (GB/T17799.2)				



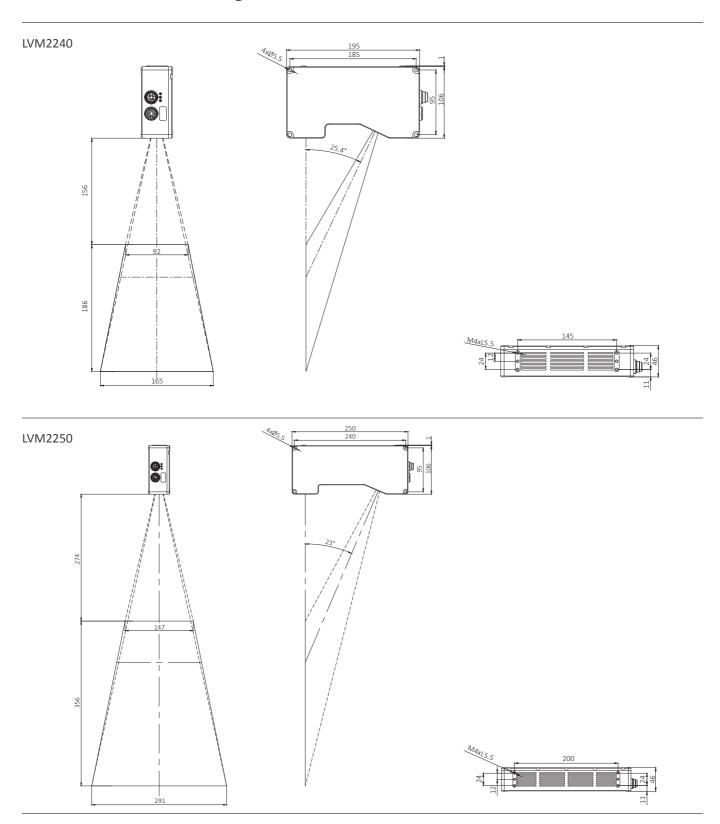
Outline dimensional drawing



LVM2230

170
180
180
180
130
130
130

Outline dimensional drawing





Product Specification

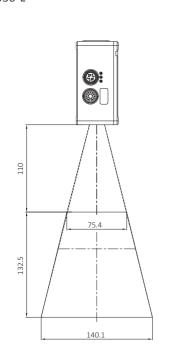
LVM23 SERIES

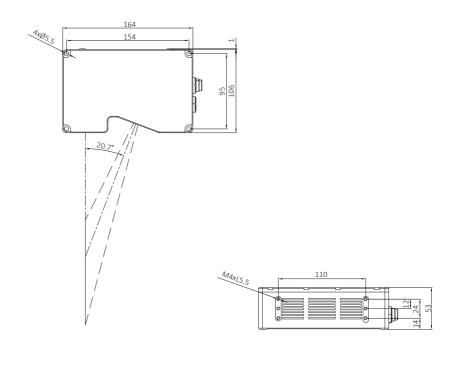
Model		LVM2330-L	LVM2340-L	LVM2350-L	LVM2370-L	LVM2390		
Data points		4200	4200	4200	4200	4200		
Clearance distance (mm)		110	167	328	495.8	357.6		
Measurement ran	ge (mm)	132.5	192.6	472	1052.6	1576.2		
Field of view (mm)	Proximal	75.4	110.8	197.1	282.4	521.2		
	Reference distance	107.8	157.6	314.6	549.8	1455.8		
	Remote	140.1	204.3	432	817.2	2390.4		
Resolution (μm)	X(Width)	18.0-33.4	26.4-48.6	46.9-102.9	67.2-194.6	124.1-596.1		
Repeatability Z (μ	m)	0.3	1	2.7	10.0	12		
Linearity Z (+/- %	of MR)	0.03%	0.04%	0.04%	0.05%	0.08%		
Light source wave	length *	405nm/660nm						
Laser class			3R					
Dimensions (mm)		53x106x164	53x106x204	53x126x254	53x106x284	57x111x280		
Weight (kg)		1.23	1.43	1.72	1.78	2.06		
Enclosure material		Aluminium						
Temperature characteristics		0.01%						
Scan rate		316-12000Hz						
Inputs		Differential encoder, laser safety enable, trigger						
Outputs		2 x digital output, RS-485 serial, 1 x analog output						
Protocols		ModbusTCP、PROFINET、ASCII						
Protection class		IP67 inserted and tightened						
Ambient light		Incandescent Lamp:≤10000lux						
Operating temperature		0 °C to +50 °C						
Storage temperature		-30 °C to +70 °C						
Working humidity		20%-85% RH						
Vibration resistan	ce	10 to 55 Hz, 1.5 mm double amplitude in X, Y and Z directions, 2 hours per direction						
Shock resistance			15 g/11 ms, positive and negative for X, Y and Z directions					
Electromagnetic p	protection	EN 61326-1:2013 (GB/T18268), EN 55011:2007-11 (GB4824, group 1, A class), EN 61000-6-2:2006-03(GB/T17799.2)						

 $[\]mbox{\ensuremath{^{\bullet}}}$ default blue laser, $\mbox{\ensuremath{^{\circ}}}$ add -R behind sensor type if red laser.

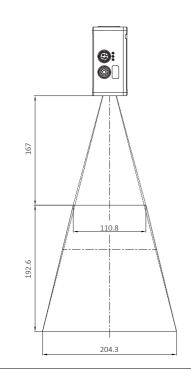
Outline dimensional drawing

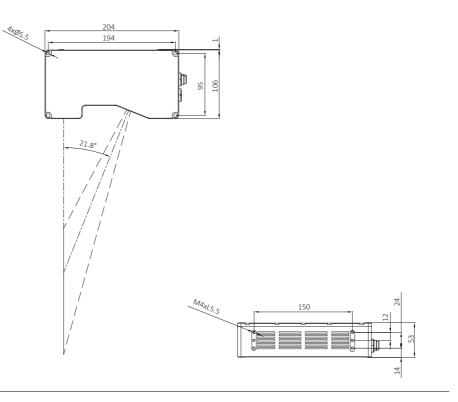
LVM2330-L





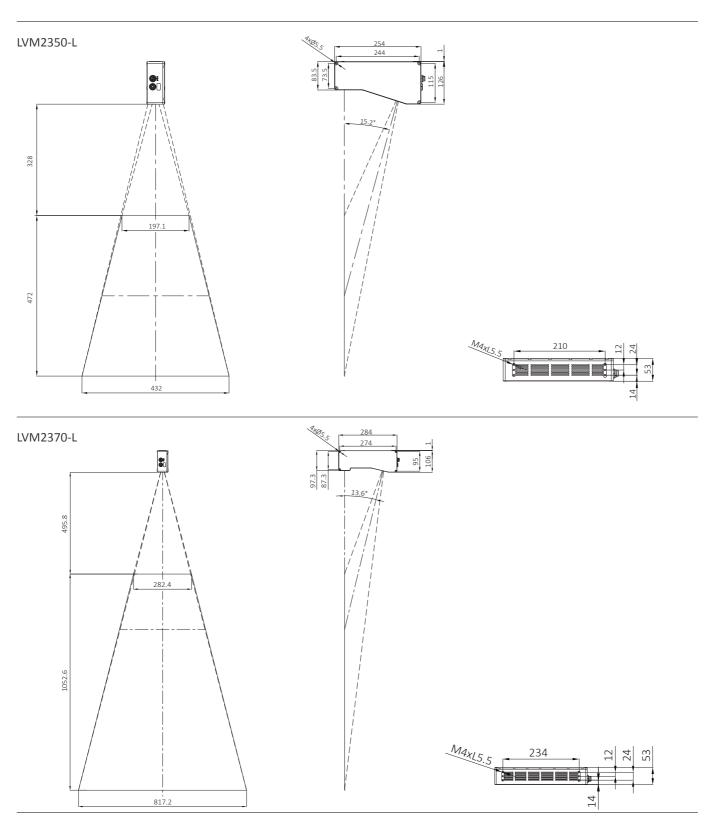




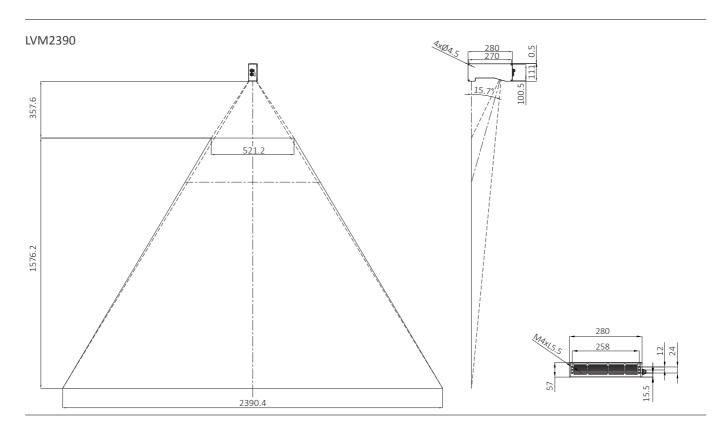




Outline dimensional drawing



Outline dimensional drawing





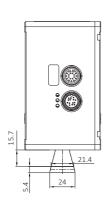
Product Specification

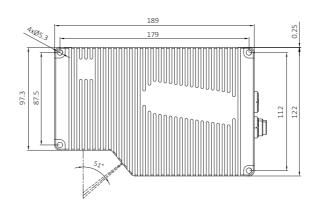
LVM25 SERIES

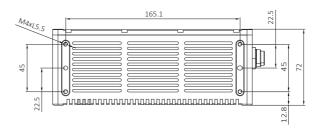
Model		LVM2520	LVM2540	LVM2550	LVM2560	LVM2570		
Data points		4096	4096	4096	4096	4096		
Clearance distance (mm)		15.7	54.5	41.5	151.2	206.5		
Measurement ran	nge (mm)	5.4	17.7	65.8	237.3	457.1		
Field of view (mm)	Proximal	21.4	46.0	115.3	298.4	363.3		
	Reference distance	22.7	50.9	155.3	452.5	669.4		
	Remote	24.0	55.7	195.3	606.5	975.4		
Resolution (μm)	X(Width)	5.2-5.8	11.2-13.6	28.2-47.7	72.9-148.1	88.7-238.1		
Repeatability Z (μ	.m)	0.1	0.3	0.5	1.2	2.0		
Linearity Z (+/- %	of MR)	0.02%	0.02%	0.02%	0.05%	0.06%		
Light source wave	elength	405	405nm 405nm/650nm					
Laser class		3В						
Dimensions (mm)		72x122x189	73x110x165	95x117x175	95x127x195	89x121x195		
Weight (kg)		2.22	1.82	2.42	2.75	2.58		
Enclosure materia	al	Aluminium						
Temperature characteristics		0.01%						
Scan rate		1800-37900Hz						
Inputs		Differential encoder, laser safety enable, trigger						
Outputs		2 x digital output, RS-485 serial, 1 x analog output						
Protocols		ModbusTCP、PROFINET、ASCII						
Protection class		IP67 inserted and tightened						
Ambient light		Incandescent Lamp:≤10000lux						
Operating temperature		0 °C to +50 °C						
Storage temperature		-30 °C to +70 °C						
Working humidity		20%-85% RH						
Vibration resistance		10 to 55 Hz, 1.5 mm double amplitude in X, Y and Z directions, 2 hours per direction						
Shock resistance		15 g/11 ms, positive and negative for X, Y and Z directions						
Electromagnetic protection EN 61326-1:2013 (GB/T18268), EN 55011:2007-1 EN 61000-6-2:2006-03 (GB/T					iss),			

Outline dimensional drawing

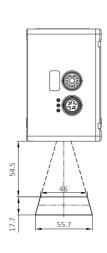
LVM2520

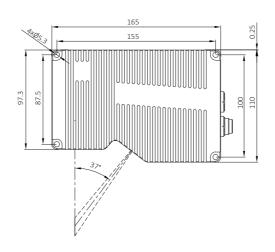


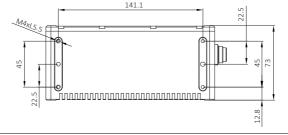




LVM2540



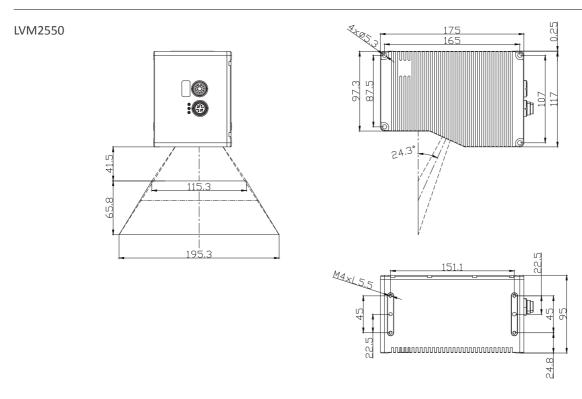


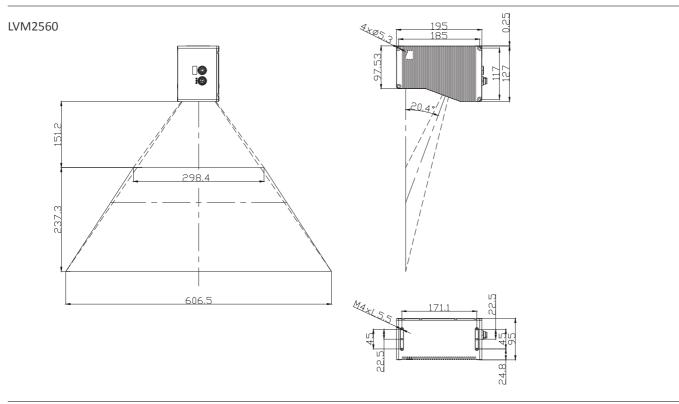




Outline dimensional drawing

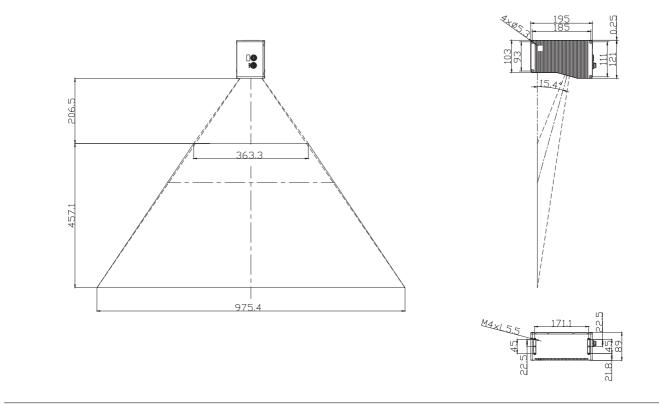






Outline dimensional drawing

LVM2570





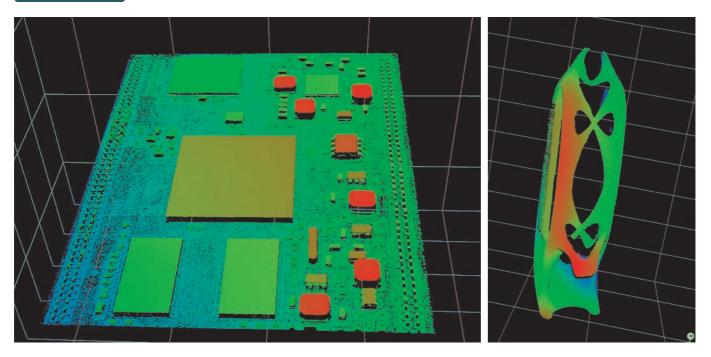




Product Features And Advantages

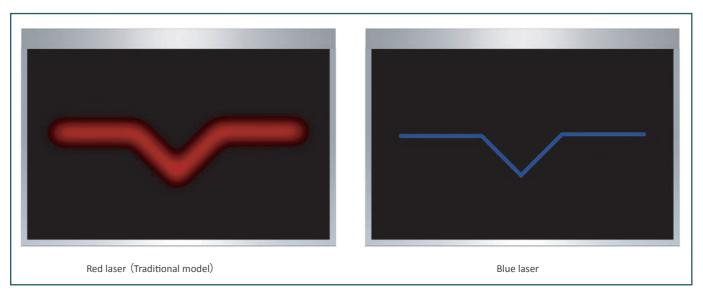


Micron-level measurement, accurately draw the shape of the target object, small dents, bumps without missing.



1 - 405nm blue laser

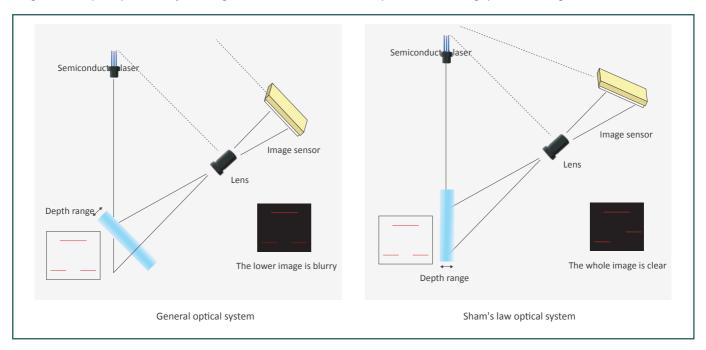
Using a 405nm blue laser, the short-wavelength laser is focused to obtain a clear line beam, allowing for more accurate measurements.





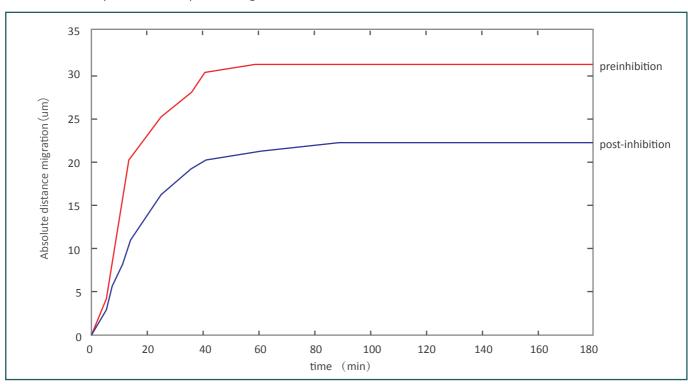
2 - Sham's law optical system

Using Sham's law optical system, the object with high and low difference can be accurately focused to achieve high-precision shooting in the whole field of view.



3 - Automatic temperature compensation

Inhibit the drift of components due to temperature changes to ensure more stable and reliable measurement data.

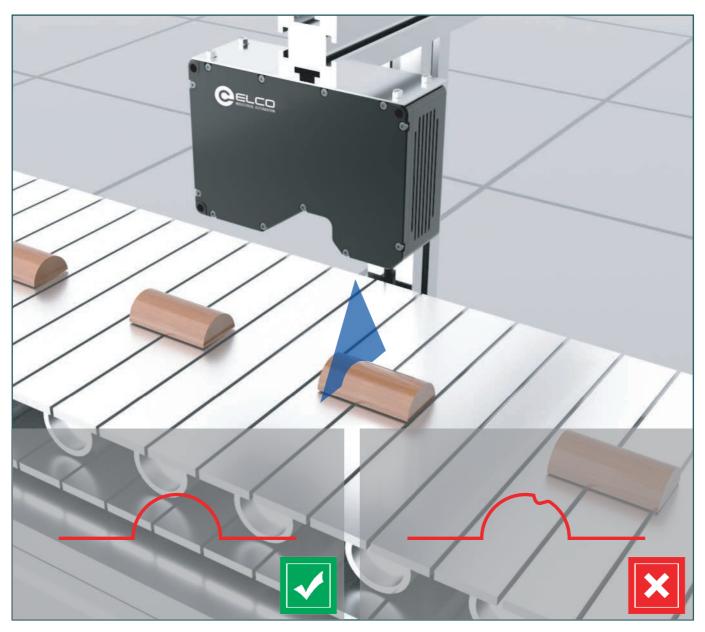


Product Features And Advantages



1 - Ultra-high speed scan sampling

Equipped with high-speed multi-channel CMOS and high-performance processor, sampling frequency up to 10HZ, easy to achieve ultra-high-speed sampling, to meet the needs of high-speed production line measurement and inspection.





2 - Real-time result output

The built-in powerful embedded 3D measurement tool processes the sampled data at high speed, and the measurement results are output in real time without additional calculation.



Product Features And Advantages



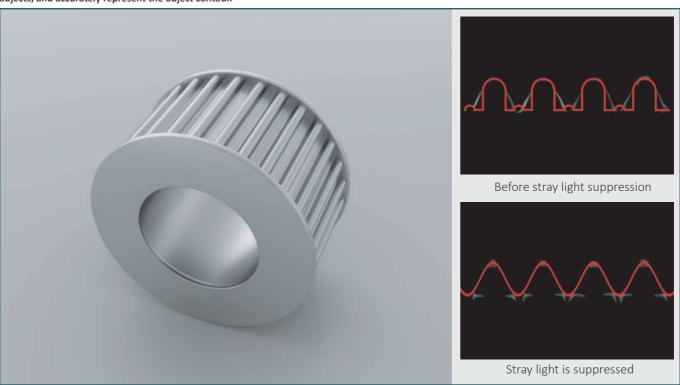
Support For Various Workpieces

Not affected by color, gloss, easily detect metal, plastic, glass and other workpieces.



1 - Stray light suppression

Through the original algorithm, it can suppress the influence of stray light caused by multiple reflections and diffuse emission of shiny objects, and accurately represent the object contour.

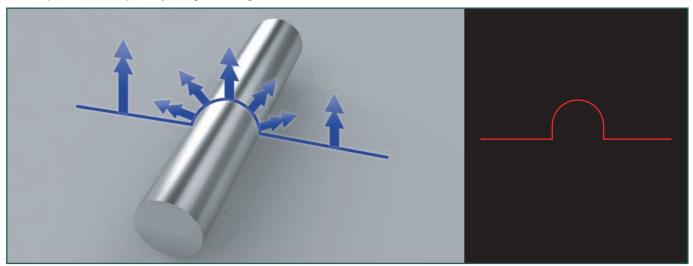




2 - High dynamic range

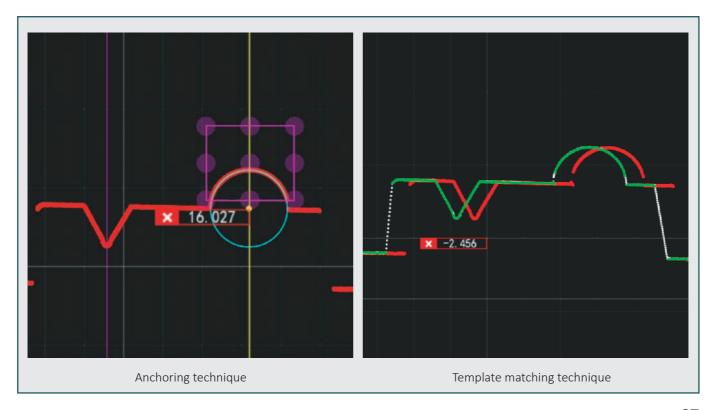
Using multiple exposure technology, the highly reflective area is low exposure, and the weakly reflective area is high exposure.

Accurately measure the shape of objects regardless of light and dark differences.





Anchor and template matching technology is used to track the local or overall characteristics of the object, and remove measurement deviations caused by conveyor vibration, sample deviation or rotation, so as to achieve stable measurement under vibration environment.

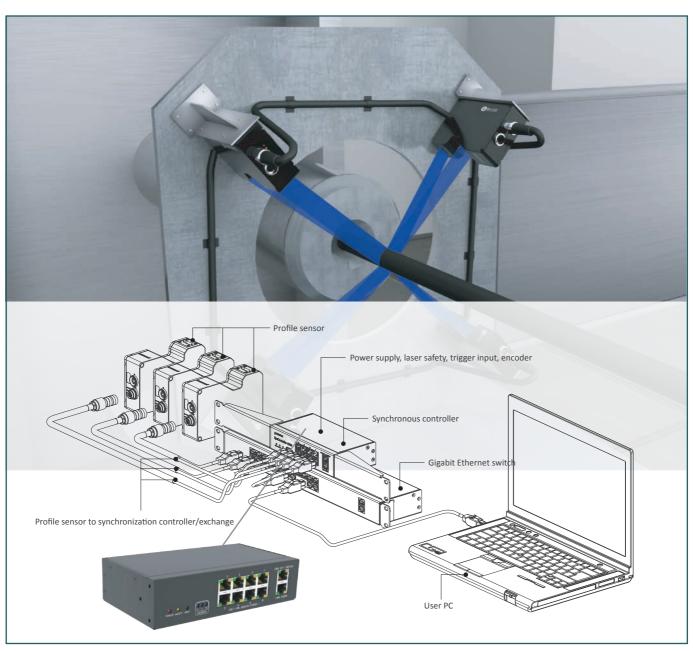


Product Features And Advantages



Strong scalability, multi-machine collaboration

A measurement system can be connected to up to 8 sensors for detection in multiple directions and multi-point detection on large workpieces.







High adaptability, rich output interface

Support multi-channel protocols, such as Modbus, ProfiNet, ASCII, etc., compatible with a variety of PLC control systems.

It supports GenTL transmission protocol and can be seamlessly connected with measurement platforms such as Haclon.

Provide SDK based on C/C++, Java, C# programming languages, convenient for users to carry out secondary development.



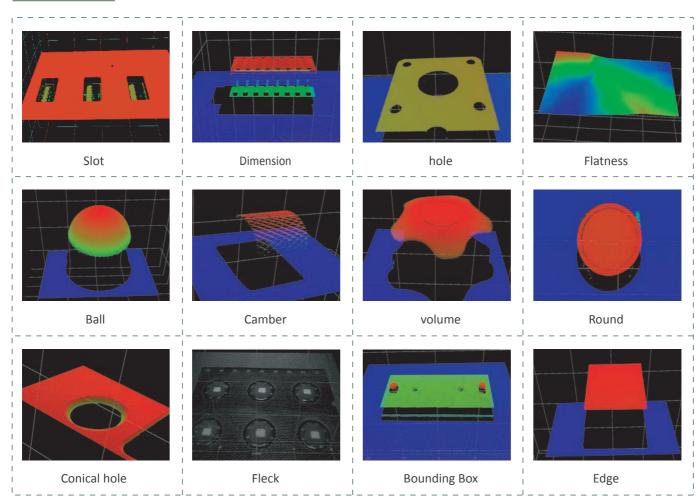
Apply Measuring Tools And Measuring Modes



Powerful, rich software features, to provide a variety of solutions.

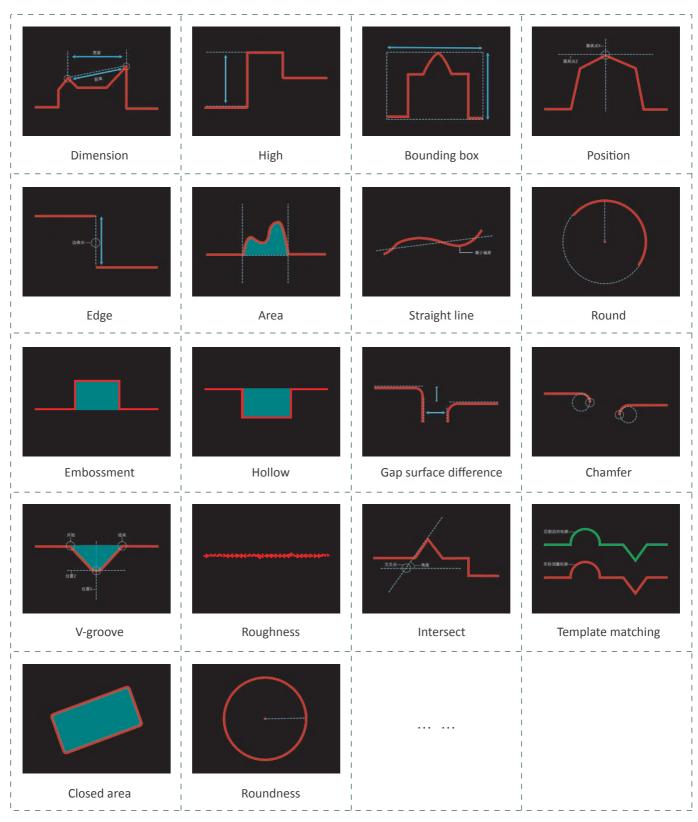
Scanning and measurement can be performed automatically with simple Settings, and the measurement results are directly output to the control system for rapid deployment.

1 - Point cloud tool





2 - Contour tool

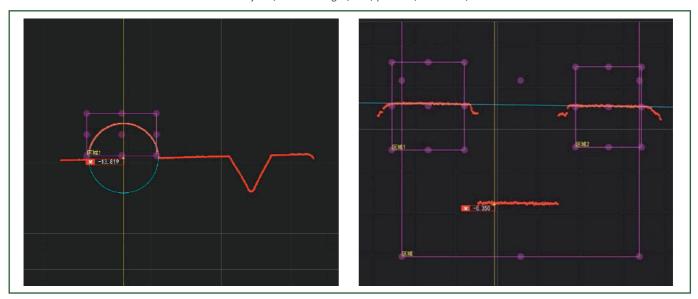


Apply Measuring Tools And Measuring Modes



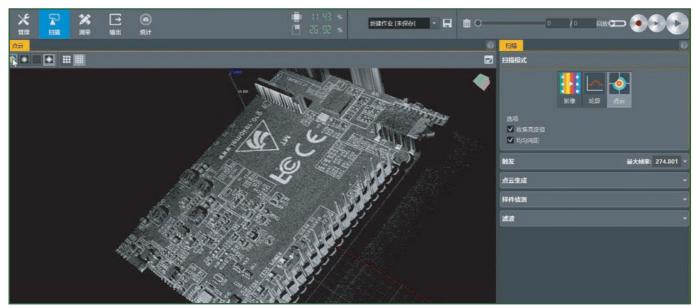
1 - Contour pattern

Used to measure cross-section characteristics of objects, such as height, size, position, clearance, chamfer and roundness.



2 - Luminance mode

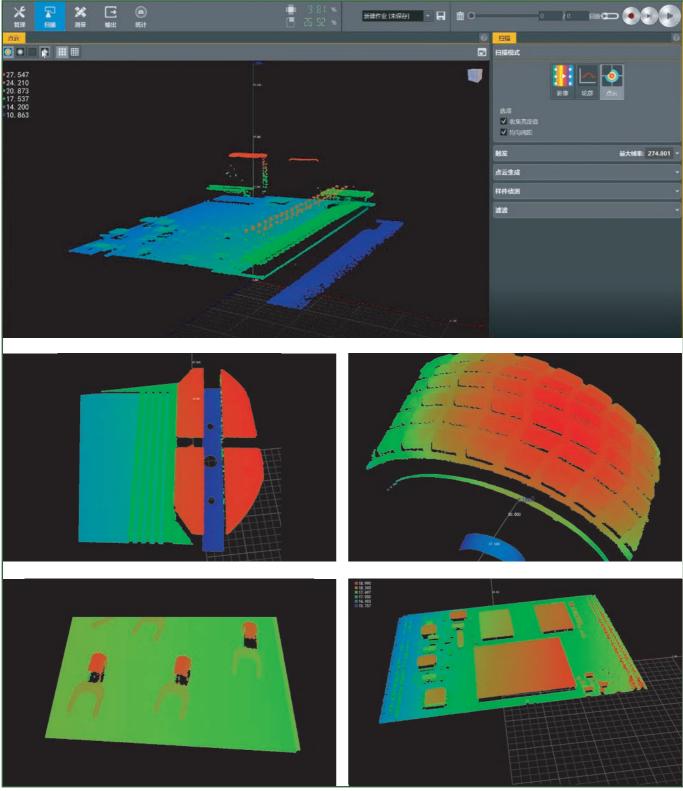
It is used to detect 2D features on the surface of objects, such as character recognition and bar code recognition.





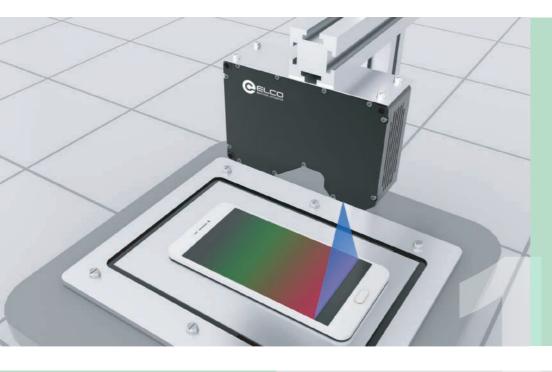
3 - Point cloud model

Used to measure surface features of objects, such as volume, plane, hole, sphere, edge and opening.



Product Application Cases

Consumer Electronics Industry Application



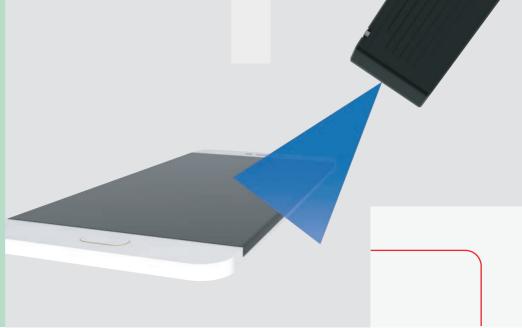
Mobile Phone Screen Detection

Detect the flatness, thickness and curvature of the mobile phone screen glass, accurately identify the surface defects such as edge breakage, pitting and dirt on the glass, and remove defective products.

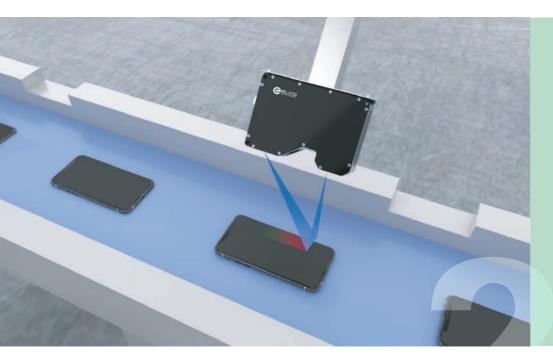
<< Flat glass screen

Flatness detection

Curved screen glass >> Chamfer detection





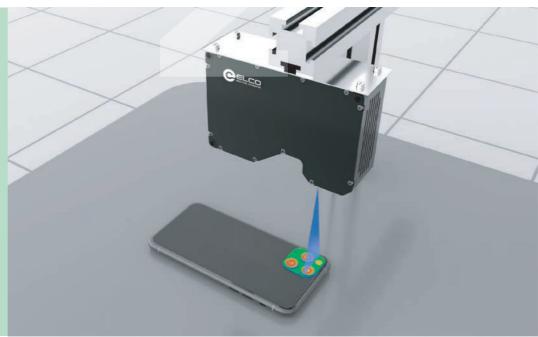


Mobile Phone Assembly Accuracy Detection

Accurately detect gaps and height differences between objects with different reflectance such as screen glass and shell to ensure assembly accuracy.

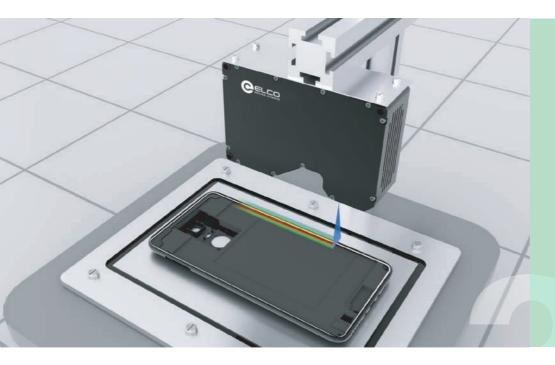
<< Screen gap detection

Camera gap detection >>



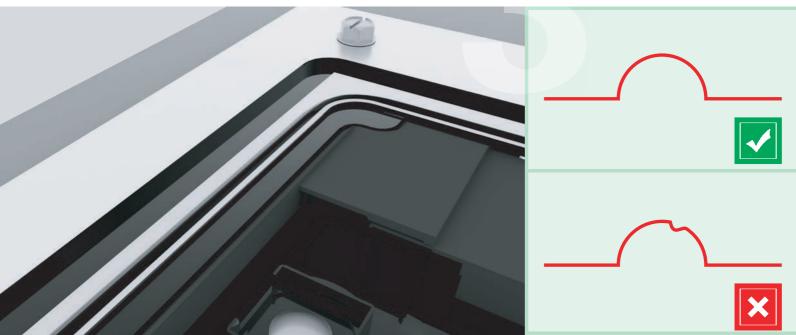
Product Application Cases

Consumer Electronics Industry Application

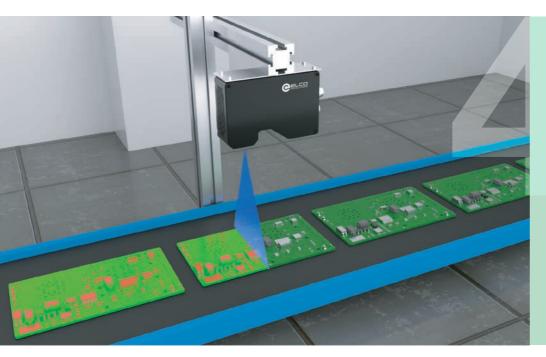


Mobile Phone Glue Path Detection

Detect the transparent and black glue of the ultra-narrow frame mobile phone glue road, accurately detect the excessive or too little glue and other anomalies.





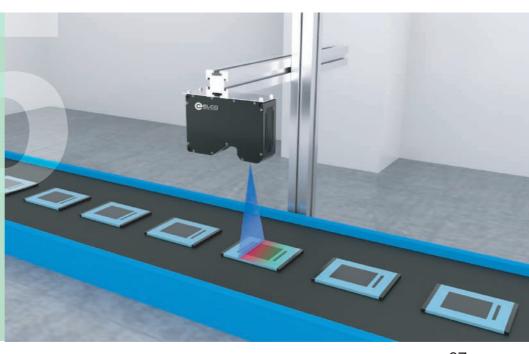


Pcb Solder Paste Test

Check whether the height and position of the solder paste are correct, and whether there is welding leakage and welding slag.

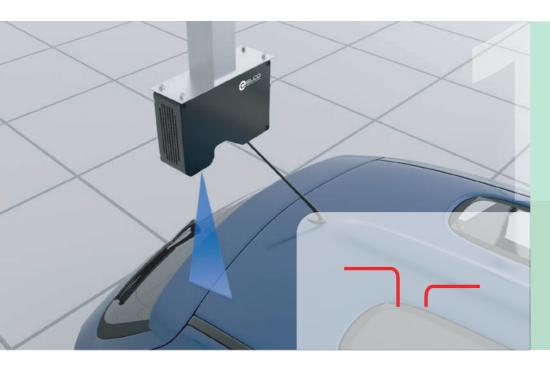
Battery Flatness Check

Detect the flatness of the battery to avoid assembly abnormalities caused by uneven batteries or foreign objects.



| | Product Application Cases

Automotive Industry Application

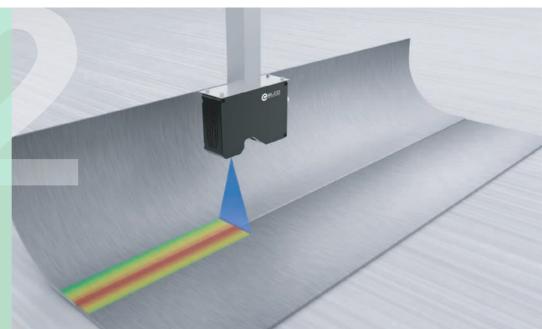


Body Clearance Surface Difference Detection

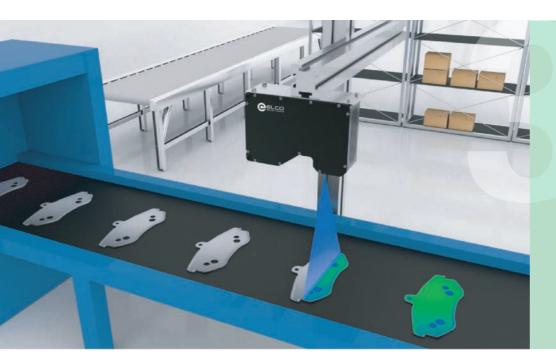
Regardless of material and reflectivity, accurately measure the gap surface difference of the body, such as Windows, mirrors, panoramic sunroofs, lights, etc. The measurement accuracy of micron level fully meets the requirements of high precision for body assembly.

Weld Shape Detection

The weld is perforated, staggered, weld height, edge bite and so on detection to prevent bad welding. Using a blue laser, subtle defects can be detected.





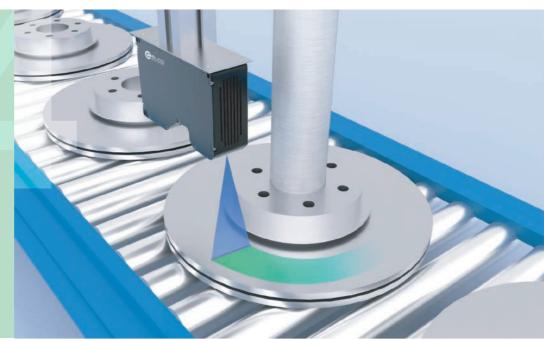


Stamping Part Inspection

By testing the size, shape, width and height of the stamping parts, judge whether there are burrs, wrinkles, pits, convex hull and other appearance defects.

Brake Disc Surface Polishing Detection

Test the surface smoothness of the brake disc to ensure smooth and smooth grinding, no burrs, sand holes, pores, etc. Accurate detection of even minor defects.



| Product Application Cases

Automotive Industry Application

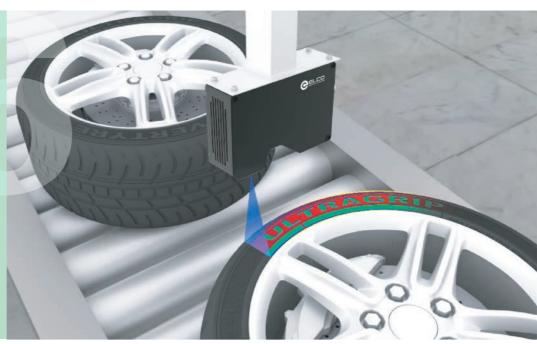


Vehicle Mounting Hole Detection

Test whether the installation hole and the position, size, etc. meet the requirements to ensure that other parts can be correctly riveted.

Tire Character Recognition

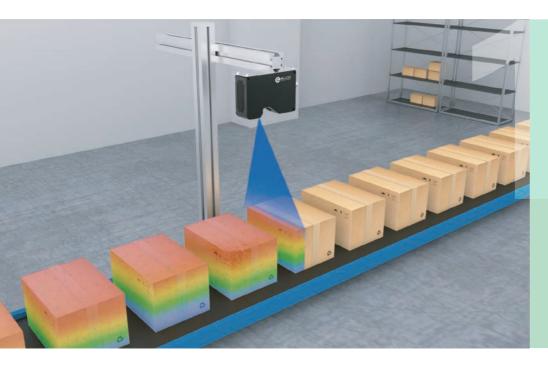
Scan the pattern or character on the side wall of the tire to generate a high-precision 3D point cloud map to verify whether its shape, height, position, etc.





Product Application Cases

Food And Packaging Industry Application

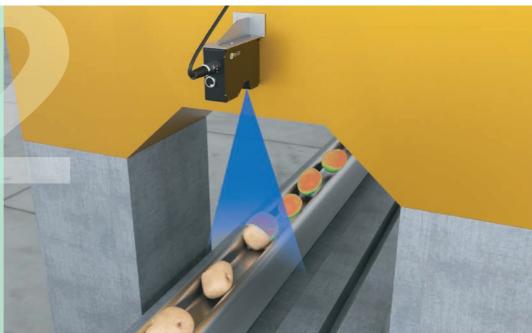


Product Packaging Inspection

Inspect the outer packaging of the packaged food to determine whether the outer packaging is damaged, folded, loophole, etc.

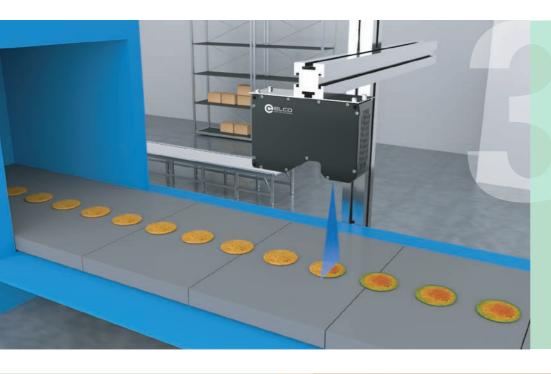
Potato Sorting

Scan the shape and size of potatoes, quickly measure the volume of potatoes, and accurately detect the surface defects of potatoes.



Product Application Cases

Food And Packaging Industry Application



Biscuit Quality Inspection

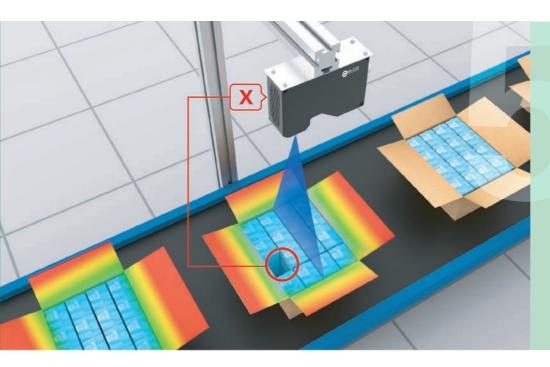
Detect the thickness and size of cookies, identify cookies with defects in appearance, and ensure that the cookie size is consistent and the thickness is uniform. It can also be used in the quality detection of potato chips, cheese slices, oatmeal bars and other food.

Package Volume Detection

Use height and width measurements to measure the volume of the carton.







Package Filling Inspection

Detect the height of the filling and use the height change to confirm if there is a filling defect.

Bottle Cap Packaging Inspection

By testing the height of the bottle cap to verify the complete package of the bottle cap, eliminate the missing bottle cap, bottle cap skew and other bad products, can be used in beer, drinks, cans, yogurt, jam, sweet wine and other bottle cap packaging detection.



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